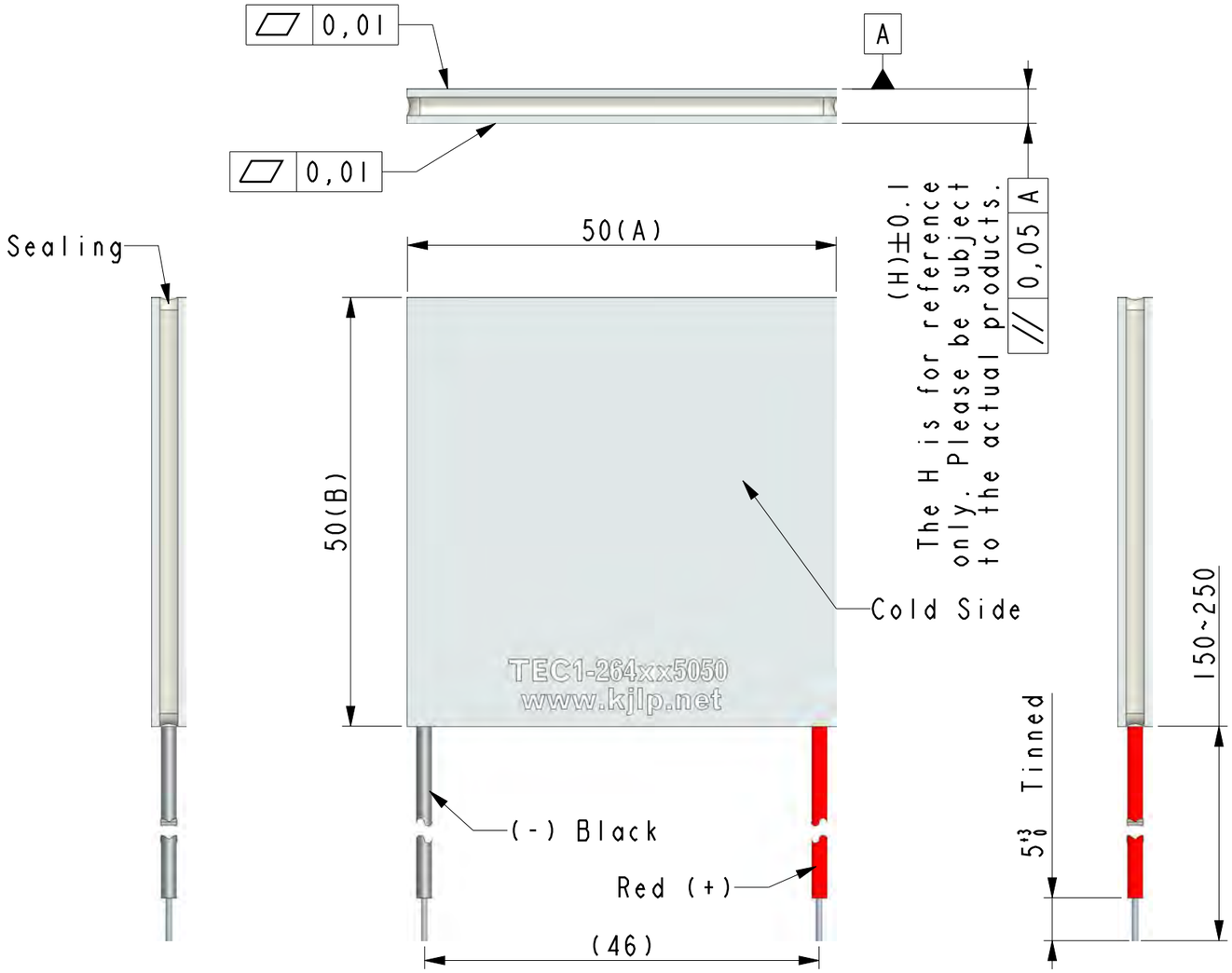
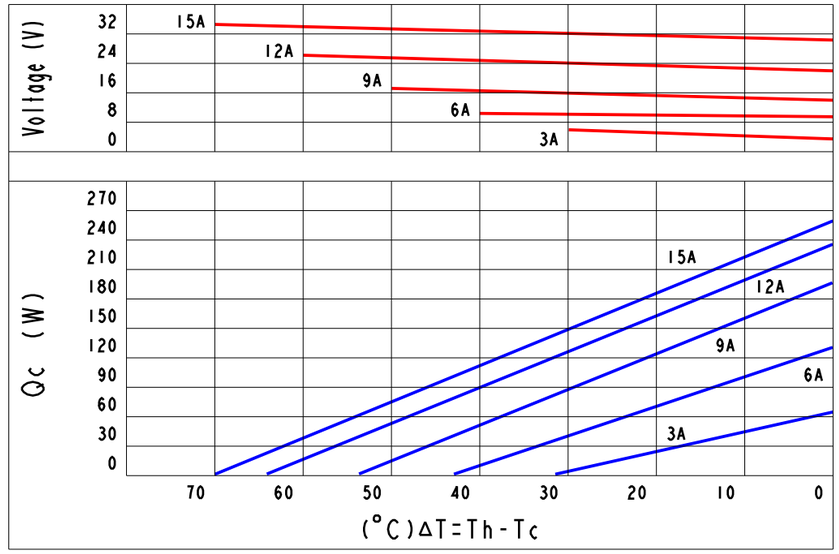
REVISIONS						
REV.	POS.	DESCRIPTION	DATE	DRW	APP	ECR#
A		INITIAL CREATION	2013/01/01	Gory	Mason	



SCALE 0,500

SCALE 0,500

Curve Chart(Be Confined To TEC1-264155050):



Part Number And Feature:

TEC	I	-	264	xx	5050		Sealing	YES
↓	↓		↓	↓	↓	↓	Operation Temperature	125°C(Max.)
Thermo Electric Chip	Stage Stack		N & P Stack Quantity	Current A(Max.)	Dimension (A)	Dimension (B)	Melting Point	138°C
							Storage Temperature	-60°C~100°C
							RoHS	YES

Technical Data:

ITEM	Part NO.	Stack(P&N)	A(Max,)	V(Max.)	Qc(W) /Th=27°C/ ΔT(°C)		DIM(A)	DIM(B)	DIM(H)
1	TEC1-264035050	264	3 A	30 V	71W	70°C	50	50	RF5.2
2	TEC1-264065050	264	6 A	30 V	109W	70°C	50	50	RF4.8
3	TEC1-264085050	264	8 A	30 V	149W	70°C	50	50	RF4.6
4	TEC1-264095050	264	9 A	30 V	169W	70°C	50	50	RF4.2
5	TEC1-264125050	264	12 A	30 V	220W	70°C	50	50	RF4.1
6	TEC1-264155050	264	15 A	30 V	270W	70°C	50	50	RF4.0

Notes:
1. Printing always on cold side.
2. Torlerance of thermo and electric parameters ±10%.
3. Please mount heat sink before you use it. also, please do not exceed the extra voltage at any time.
4. Please contact with us if you need Melting Point 183°C (Operation Temperature 150°C Max.) and 235°C(Operation Temperature 200°C Max.) type.

*DO NOT SCALE DRAWING

1. UNLESS OTHERWISE SPECIFIED, DIMENSIONS ARE MM
2 TOLERANCE ARE AS FOLLOWS:
0 < X < 2 ± 0.06
2 < X < 10 ± 0.08
10 < X < 50 ± 0.12
50 < X < 100 ± 0.16
100 < X < 200 ± 0.20
200 < X < 300 ± 0.30
ANGLES ± 0.5°

MATERIAL:

SIGNATURE		DATE
DRAWN BY	Gary	2013/01/01
CHECKED BY	Justin	2013/01/01
ENGR	Vivi	2013/01/01
APPROVED BY	Mason	2013/01/01
ISSUED BY	Jack	2013/01/01

PART NO.	TEC1-264xx5050	DESCRIPTION	DC 30V(Max.),3~15A(Max.),264 P&N,50*50mm
CAD MODLE:	TEC1-264xx5050.prt	SCALE: 1:1	REV: A
CAD DWG:	TEC1-264xx5050.drw	SIZE: A3	SHEET: 1 OF 1

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